

## **Advanced Product / Process Change Notice**

Date: June, 16, 2014

APCN No.: Z200-APCN-DM201406-01- P

Change Title: 1Mx16 SDR technology migration from 90nm to 65 nm Change item: ☑ Design ☐ Raw Material ☐ Wafer FAB ☐ Package Assembly ☐ Testing ☐ Others: Affected Product(s): W9816G6IH, W9816G6IB (1Mx16 SDR with 90nm technology) Description of Change(s): Technology migration (90nm  $\rightarrow$  65nm) for 1Mx16 SDR. Reason for Change(s): According to Winbond product roadmap, launch new 1Mx16 SDR with 65nm technology. Impact of Change(s): (positive & negative) Form: No Change Fit: No Change Function: No Concern (Compatible between 90nm and 65nm) Reliability: On-going Hazardous Substances: No Concern (Please refer to Attachment I) Qualification Plan/ Results: The qualification is in progress and expected come out in July /B /2014. Implementation Plan: □ Date Code : \_\_\_\_\_ onward □ Lot No.: \_\_\_\_\_ onward ☑ Proposed first ship date: July / 31 /2014 (schedule) . The follow-up disposition of 90 nm 1Mx16 SDR: 1) The date of Last-buy orders for the 90 nm 1Mx16 SDR: October, 31, 2014. 2) The last shipment date of the 90 nm 1Mx16 SDR: January, 31, 2015. Originator:(QA Responsible: (QA Approval:(QRA Yu-Sung, cheng 44 Chang Sec. Manager) Dept. Manager) Director) Name: <u>Betty Huang</u> TEL:<u>886-3-5678168</u> (ext.86549) FAX: <u>886-3-5796124</u> Contact for Questions & Address: #539, Sec. 2, Wenxing Rd., Jhubei City, Hsinchu County 302, Taiwan **Concerns** E-mail: <u>Hyhuang8@winbond.com</u>



## **Customer Comments:**

Note: Please sign this notice, and return to Winbond contact within 30 days. If no response is received within 30 days, this Change Request will be assumed to meet your approval.

■ Approval	■ Disapproval	□ Conditional Approval :
Date:		
Dept. name:		
Person in charge	9:	<u>.</u>



Table 1 The part no comparison table

Product	90nm Part No	65nm Part No
1Mx16 SDR TSOP50	W9816G6IH	W9816G6JH
1Mx16 SDR VFBGA60	W9816G6IB	W9816G6JB